

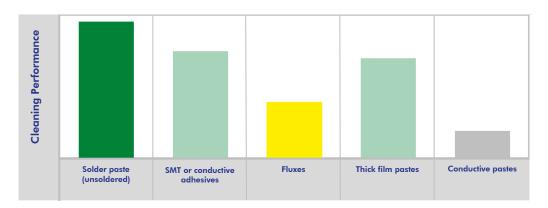
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Cleaning medium for the removal of solder pastes, SMT adhesives and thick film pastes from stencils and screens

ZESTRON® SD 301 is a solvent-based cleaning agent for the removal of solder pastes, SMT adhesives as well as thick film pastes from stencils and screens in explosion-proof spray-in-air systems. Its fast drying time allows short cleaning processes. ZESTRON® SD 301 can also be used to clean misprinted assemblies. Its high flash point also allows the manual use and the application in printers.

#### Areas of application - Stencil & misprinted board cleaning





#### Advantages compared to other cleaners

- Due to its wide process window, ZESTRON® SD 301 reliably removes solder pastes, SMT adhesives and resistor pastes etc. from stencils and screens as well as flux residues from misprinted assemblies.
- High loading capabilities, long bath life and therefore low cleaning costs.
- Very fast drying time and thus short overall process time.
- Applicable at ambient cleaning temperature.

#### **Process Steps**

Cleaning Process	1. Cleaning	2. Rinsing	3. Drying
Explosion-proof Spray-in-air-system	ZESTRON® SD 301	ZESTRON® SD 301	Circulating or compressed air

# **Technical Information**



### Independent Test Center - Largest choice of leading machines, chemistry & analytics





Visit our Machine Test Center and clean your stencils & screens under production conditions in cleaning machines of leading international equipment suppliers. Our process engineers will help you independently of any supplier to find the most suitable combination of equipment & cleaning agent for your requirements. Following the cleaning trials, all results will be reviewed immediately in our Analytical Center to verify the required cleanliness.

#### Contact ZESTRON's process engineers for cleaning trials:

Europe: Phone +49 (841) 63526; techsupport@zestron.com / South Asia: Phone +604 (3996) 100; support@zestronasia.com

Or visit our website for a virtual tour: http://www.zestron.com/en/company/virtual-company-tour.html

#### **Technical Data**

Density	(g/ccm) at 20°C/68°F	0.88
Surface tension	(mN/m) at 25°C/77°F	26.0
Boiling range	°C/°F	150 – 170 / 302 – 338
Flash point	°C/°F	47 / 117
pH value	10g/l H₂O	Neutral
Vapor pressure	(mbar) at 20°C/68°F	2
Cleaning temperature	°C/°F	Room temperature
Solubility in water		Soluble
Application concentration	Ready-to-use	Pure
HMIS Rating	Health-Flammability-Reactivity	1 – 2 – 0

### **Product Features & Cleaning Standards**



100% compliance with EU guidelines (RoHS 1, 2 & 3, WEEE)



Extensively tested and suitable for cleaning lead-free solder pastes



Product is free of any critical substances according to SIN & SVHC lists

Stencils cleaned with ZESTRON $^{\otimes}$  SD 301 in a ZESTRON specified process meet the following industry standards:

IPC-7526 Manual for cleaning of stencils and misprinted boards

# **Technical Information**



### **Environmental, health & safety regulations**

- ZESTRON® SD 301 is formulated free of any halogenated compounds and biodegradable.
- Water rinsing is not necessary which results in the elimination of waste water concerns.
- The product is a hazardous material and according to EU standards requires specific labelling.
- Refer to the SDS for specific handling precautions and instructions.

### **Availability & Storage**

1 Liter	✓
5 Liter	✓
25 Liter	✓
200 Liter	✓

- Available as ready-to-use solution
- Store ZESTRON® SD 301 in the original container at a temperature between 5 - 30°C / 41 - 86°F.
- The product has a minimum shelf life of 5 years in factory sealed containers.



#### **Further product information**

- Material Compatibility
   Please review the Material Compatibility overview before using the cleaning agent
- Filter recommendation
   To further extend the bath life of ZESTRON® SD 301, filtration is recommended.
- Safety data sheet